

Pin	Symbol	Function
1	OUT1 (Load, L)	Output 1, protected high-side power output of channel 1
2	GND	Logic ground
3	IN1	Input 1, activates channel 1 in case of logical high signal
4	Vbb	Positive power supply voltage, the tab is shorted to this pin
5	ST	Diagnostic feedback: open drain, low on failure
6	IN2	Input 2, activates channel 2 in case of logical high signal
7	OUT2 (Load, L)	Output 2, protected high-side power output of channel 2

Maximum Ratings at T _j = 25 °C unless otherwise specified							
Parameter	Symbol	Values	Unit				
Supply voltage (overvoltage protection see page 4)	$V_{ m bb}$	43	V				
Supply voltage for short circuit protection T _{j Start} =-40+150°C	$V_{ m bb}$	34	V				
Load dump protection ²⁾ $V_{\text{LoadDump}} = U_{\text{A}} + V_{\text{S}}, U_{\text{A}} = 13.5 \text{ V}$ $R_{\text{I}}^{3} = 2 \Omega, R_{\text{L}} = 5.3 \Omega, t_{\text{d}} = 200 \text{ ms}, \text{IN} = \text{low or high}$	V _{Load dump} ⁴)	60	V				
Load current (Short circuit current, see page 5)	/ ∟	self-limited	Α				
Operating temperature range	T _j	-40+150	°C				
Storage temperature range	T_{stg}	-55+150					
Power dissipation (DC), T _C ≤ 25 °C	P _{tot}	36	W				
Inductive load switch-off energy dissipation, single pulse $V_{bb} = 12V$, $T_{j,start} = 150^{\circ}C$, $T_{C} = 150^{\circ}C$ const. one channel, $I_{L} = 2.3$ A, $Z_{L} = 89$ mH, 0 Ω :	E _{AS}	290	mJ				
both channels parallel, $I_L = 4.4 \text{ A}$, $Z_L = 47 \text{ mH}$, 0Ω :		580					
see diagrams on page 9							
Electrostatic discharge capability (ESD) IN: (Human Body Model) all other pins: acc. MIL-STD883D, method 3015.7 and ESD assn. std. S5.1-1993	V _{ESD}	1.0 2.0	kV				
Input voltage (DC)	V _{IN}	-10 +16	V				
Current through input pin (DC)	I _{IN}	±2.0	mA				
Current through status pin (DC)	<i>I</i> _{ST}	±5.0					
see internal circuit diagrams page 7							

Data Sheet 2 2013-10-11

Supply voltages higher than V_{bb(AZ)} require an external current limit for the GND and status pins, e.g. with a 150 Ω resistor in the GND connection and a 15 k Ω resistor in series with the status pin. A resistor for the protection of the input is integrated. $R_{\rm I}$ = internal resistance of the load dump test pulse generator $V_{\rm Load\ dump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839



Thermal Charact	eristics					
Parameter and Conditions		Symbol		Values	}	Unit
			min	typ	max	
Thermal resistance	chip - case, both channels: each channel:	R_{thJC}			3.5 7.0	K/W
	junction - ambient (free air):	R_{thJA}			75	
S	SMD version, device on PCB ⁵):			37		

Electrical Characteristics

Parameter and Conditions, each channel	Symbol		Values	;	Unit	
at $T_j = 25$ °C, $V_{bb} = 12$ V unless otherwise specified		min	typ	max		

Load Switching Capabilities and Characteristics

Ron		160	200	mΩ
		320	400	
	1.8	2.3		
$I_{L(ISO)}$	3.5	4.4		Α
I _{L(GNDhigh)}	-		10	mA
<i>t</i> on	80	200	400	μS
$t_{ m off}$	80	200	400	
dV/dt _{on}	0.1		1	V/μs
-d V/dt _{off}	0.1		1	V/μs
	$I_{L(ISO)}$ $I_{L(GNDhigh)}$ t_{on} t_{off} dV/dt_{on}	IL(ISO) 1.8 JL(ISO) 3.5 IL(GNDhigh) ton 80 toff 80 dV/dton 0.1	320 I	320 400 1.8 2.3 3.5 4.4 10 10 10 10 10

Data Sheet 3 2013-10-11

 $^{^{5})}$ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for $V_{\mbox{\footnotesize{bb}}}$ connection. PCB is vertical without blown air.



Parameter and Conditions, ea	Symbol		Values		Unit	
at $T_j = 25$ °C, $V_{bb} = 12$ V unless otherward	vise specified		min	typ	max	
Operating Parameters						
Operating voltage ⁶⁾	<i>T</i> _j =-40+150°C:	$V_{\rm bb(on)}$	5.0		34	V
Undervoltage shutdown	<i>T</i> _j =-40+150°C:	V _{bb(under)}	3.5		5.0	V
Undervoltage restart	T _j =-40+25°C: T _j =+150°C:	V _{bb(u rst)}			5.0 7.0	V
Undervoltage restart of charge page 12	oump	$V_{ m bb(ucp)}$		5.6	7.0	V
Undervoltage hysteresis $\Delta V_{bb(under)} = V_{bb(u rst)} - V_{bb(under)}$		$\Delta V_{ m bb(under)}$		0.2		V
Overvoltage shutdown	<i>T</i> _j =-40+150°C:	V _{bb(over)}	34		43	V
Overvoltage restart	$T_{\rm j}$ =-40+150°C:	V _{bb(o rst)}	33			V
Overvoltage hysteresis	<i>T</i> _j =-40+150°C:	$\Delta V_{\rm bb(over)}$		0.5		V
Overvoltage protection ⁷⁾ I _{bb} =40 mA	<i>T</i> _j =-40+150°C:	$V_{\rm bb(AZ)}$	42	47		V
Standby current (pin 4),		I _{bb(off)}				μΑ
$V_{IN}=0$	<i>T</i> _j =-40+150°C:			90	150	
Operating current (Pin 2) ⁸), V_{IN} = both channels on, T_I =-40+15		/ _{GND}		0.6	1.2	mA
Operating current (Pin 2)8) one channel on, T _i =-40+150	°C:,	I _{GND}		0.4	0.7	mA

At supply voltage increase up to V_{bb} = 5.6 V typ without charge pump, $V_{OUT} \approx V_{bb}$ - 2 V

See also $V_{ON(CL)}$ in table of protection functions and circuit diagram page 8.

Add I_{ST} , if $I_{ST} > 0$, add I_{IN} , if $V_{IN} > 5.5 \text{ V}$



Parameter and Conditions, each channel	Symbol		Values		Unit
at $T_j = 25$ °C, $V_{bb} = 12$ V unless otherwise specified		min	typ	max	
Protection Functions ⁹⁾					
Initial peak short circuit current limit (pin 4 to 1 or 7)	I _{L(SCp)}				
$T_j = -40$ °C: $T_j = 25$ °C: $T_j = +150$ °C:		5.5 4.5 2.5	9.5 7.5 4.5	13 11 7	Α
Repetitive short circuit shutdown current limit	I _{L(SCr)}				
$T_j = T_{jt}$ (see timing diagrams, page 12)		-	4		Α
Output clamp (inductive load switch off) at $V_{\text{OUT}} = V_{\text{bb}} - V_{\text{ON(CL)}}$ $I_{\text{L}} = 40 \text{ mA}$:	$V_{ m ON(CL)}$	41	47	53	V
Thermal overload trip temperature	$T_{\rm jt}$	150			°C
Thermal hysteresis	$\Delta T_{\rm jt}$		10		K
Reverse battery (pin 4 to 2) 10)	- V _{bb}			32	V
Reverse battery voltage drop (Vout > Vbb)					
$I_L = -1.9 \text{ A}$, each channel $T_j = 150 \text{ °C}$:	-V _{ON(rev)}		610		mV
Diagnostic Characteristics					
Open load detection current (included in standby current I _{bb(off)})	I _{L(off)}		30		μΑ
Open load detection voltage T_j =-40150°C:	$V_{\rm OUT(OL)}$	2	3	4	V

۰,

Data Sheet 5 2013-10-11

Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

Requires $150~\Omega$ resistor in GND connection. The reverse load current through the intrinsic drain-source diode has to be limited by the connected load. Note that the power dissipation is higher compared to normal operating conditions due to the voltage drop across the intrinsic drain-source diode. The temperature protection is not active during reverse current operation! Input and Status currents have to be limited (see max. ratings page 2 and circuit page 8).



Parameter and Conditions, each channel	Symbol		Values		Unit
at $T_j = 25$ °C, $V_{bb} = 12$ V unless otherwise specified		min	typ	max	
Input and Status Feedback ¹¹⁾					
Input resistance T_j =-40150°C, see circuit page 7	R _I	2.5	3.5	6	kΩ
Input turn-on threshold voltage	$V_{IN(T+)}$	1.7		3.5	V
Input turn-off threshold voltage $T_j = -40$	$V_{\text{IN(T-)}}$	1.5			V
Input threshold hysteresis	$\Delta V_{\text{IN(T)}}$		0.5		V
Off state input current (pin 3 or 6), $V_{IN} = 0.4 \text{ V}$, $T_{j} = -40+150^{\circ}\text{C}$	I _{IN(off)}	1		50	μΑ
On state input current (pin 3 or 6), $V_{IN} = 3.5 \text{ V}$, $T_j = -40+150^{\circ}\text{C}$	I _{IN(on)}	20	50	90	μΑ
Delay time for status with open load after Input neg. slope (see diagram page 12)	t _{d(ST OL3)}		220		μS
Status output (open drain)					
Zener limit voltage $T_j = -40 + 150$ °C, $I_{ST} = +1.6$ mA:	V _{ST(high)}	5.4	6.1		V
ST low voltage $T_{j} = -40 + 25$ °C, $I_{ST} = +1.6$ mA:	$V_{\rm ST(low)}$			0.4	
$T_{\rm j}$ = +150°C, $I_{\rm ST}$ = +1.6 mA:				0.6	

Data Sheet 6 2013-10-11

If a ground resistor R_{GND} is used, add the voltage drop across this resistor.



Truth Table

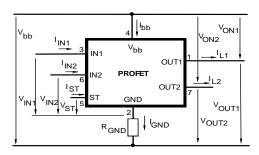
		IN1	IN2	OUT1	OUT2	ST	ST
						BTS611L1	BTS612N1
Normal operation		L	L	L	L	Н	Н
		L	Н	L	Н	Н	Н
		Н	L	Н	L	Н	Н
		Н	Н	Н	Н	Н	Н
Open load	Channel 1	L	L	Z	L	H(L ¹²⁾)	L
		L	Н	Z	Н	Н	Н
		Н	X	Н	Х	L	Н
	Channel 2	L	L	L	Z	H(L ¹²⁾)	L
		Н	L	Н	Z	Н	Н
		X	Н	Х	Н	L	Н
Short circuit to Vbb	Channel 1	L	L	Н	L	L ¹³)	L
		L	Н	Н	Н	Н	Н
		Н	X	Н	Х	H(L ¹⁴⁾)	Н
	Channel 2	L	L	L	Н	L13)	L
		Н	L	Н	Н	H ,	Н
		Х	Н	X	Н	H(L ¹⁴⁾)	Н
Overtemperature	both channel	L	L	L	L	Н	Н
		Х	Н	L	L	L	L
		Н	Х	L	L	L	L
	Channel 1	L	Х	L	Х	Н	Н
		Н	Х	L	Х	L	L
	Channel 2	Х	L	Х	L	Н	Н
		Х	Н	Х	L	L	L
Undervoltage/ Overvoltage		Х	X	L	L	Н	Н

L = "Low" Level H = "High" Level X = don't care

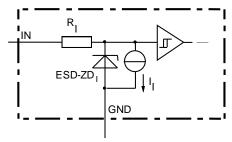
Z = high impedance, potential depends on external circuit

Status signal after the time delay shown in the diagrams (see fig 5. page 12)

Terms



Input circuit (ESD protection)



ESD zener diodes are not to be used as voltage clamp at DC conditions. Operation in this mode may result in a drift of the zener voltage (increase of up to 1 V).

Data Sheet 7 2013-10-11

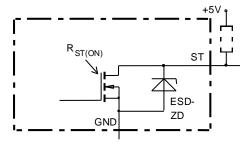
¹²⁾ With additional external pull up resistor

An external short of output to $V_{\rm bb}$, in the off state, causes an internal current from output to ground. If R_{GND} is used, an offset voltage at the GND and ST pins will occur and the V_{ST low} signal may be errorious.

Low resistance to $V_{
m bb}$ may be detected in the ON-state by the no-load-detection



Status output

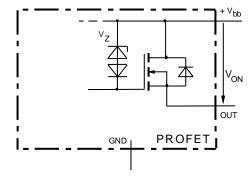


ESD-Zener diode: 6.1 V typ., max 5 mA;

 $R_{ST(ON)}$ < 380 Ω at 1.6 mA, ESD zener diodes are not to be used as voltage clamp at DC conditions.

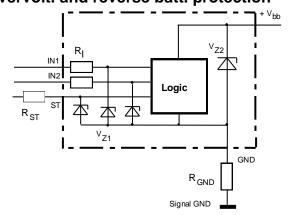
Operation in this mode may result in a drift of the zener voltage (increase of up to 1 V).

Inductive and overvoltage output clamp



Von clamped to 47 V typ.

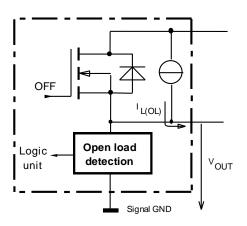
Overvolt. and reverse batt. protection



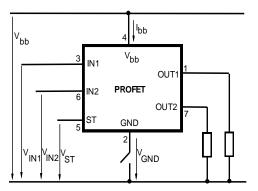
 V_{Z1} = 6.1 V typ., V_{Z2} = 47 V typ., R_{I} = 3.5 k Ω typ, R_{GND} = 150 Ω

Open-load detection

OFF-state diagnostic condition: $V_{OUT} > 3 \text{ V typ.}$; IN low

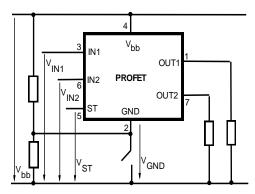


GND disconnect



Any kind of load. In case of Input=high is $V_{OUT} \approx V_{IN} - V_{IN(T+)}$. Due to $V_{GND} > 0$, no $V_{ST} = low$ signal available.

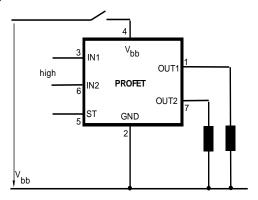
GND disconnect with GND pull up



Any kind of load. If $V_{GND} > V_{IN} - V_{IN(T+)}$ device stays off Due to $V_{GND} > 0$, no $V_{ST} = low$ signal available.

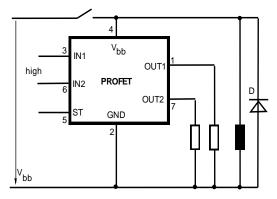


V_{bb} disconnect with energized inductive load



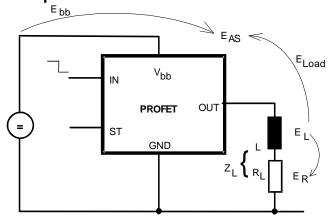
Normal load current can be handled by the PROFET itself.

V_{bb} disconnect with charged external inductive load



If other external inductive loads L are connected to the PROFET, additional elements like D are necessary.

Inductive Load switch-off energy dissipation



Energy stored in load inductance:

$$E_L = \frac{1}{2} \cdot L \cdot I_1^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

$$E_{AS} = E_{bb} + E_L - E_R = \int V_{ON(CL)} \cdot i_L(t) dt$$

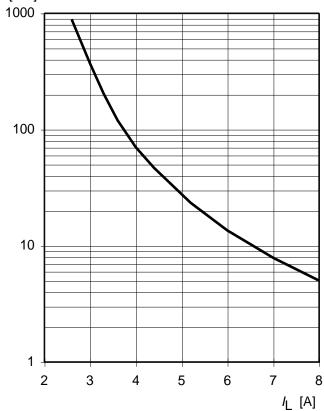
with an approximate solution for $R_L > 0 \Omega$:

$$E_{\text{AS}} = \frac{I_{\text{L}} \cdot L}{2 \cdot R_{\text{L}}} \cdot \left(V_{\text{bb}} + |V_{\text{OUT(CL)}}| \right) \cdot \ln \left(1 + \frac{I_{\text{L}} \cdot R_{\text{L}}}{|V_{\text{OUT(CL)}}|} \right)$$

Maximum allowable load inductance for a single switch off (both channels parallel)

$$L = f(I_L)$$
; $T_{j,start} = 150$ °C, $T_C = 150$ °C const.,
 $V_{bb} = 12$ V, $R_L = 0$ Ω

L [mH]

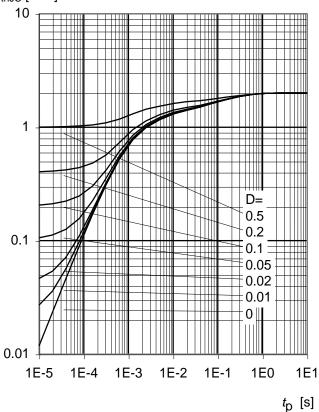




Typ. transient thermal impedance chip case

 $Z_{thJC} = f(t_p)$, one Channel active

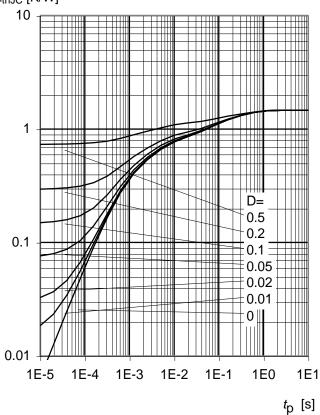
Z_{thJC} [K/W]



Transient thermal impedance chip case

 $Z_{thJC} = f(t_p)$, both Channel active

 Z_{thJC} [K/W]





Timing diagrams

Both channels are symmetric and consequently the diagrams are valid for each channel as well as for permuted channels

Figure 1a: V_{bb} turn on:

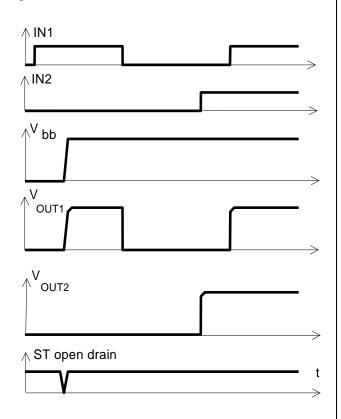


Figure 2a: Switching a lamp:

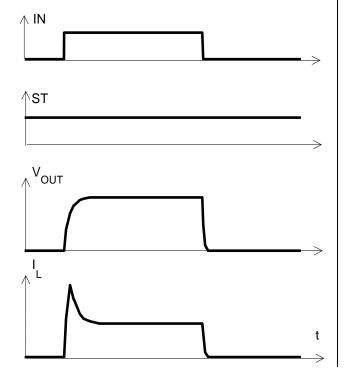


Figure 2b: Switching an inductive load

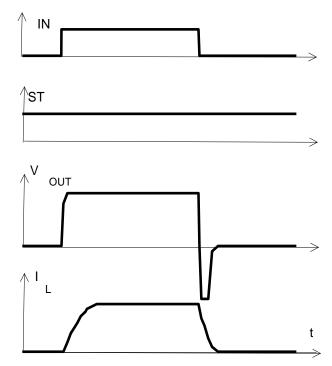
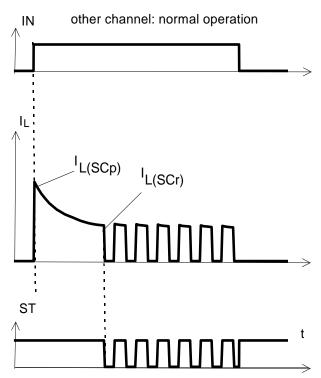




Figure 3a: Short circuit shut down by overtempertature, reset by cooling



Heating up may require several milliseconds, depending on external conditions

Figure 4a: Overtemperature: Reset if $T_j < T_{jt}$

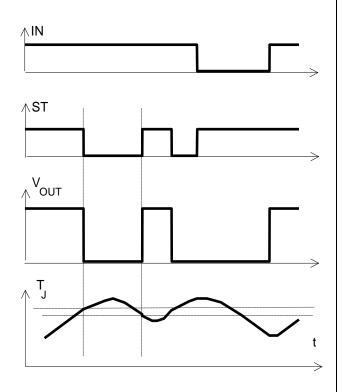
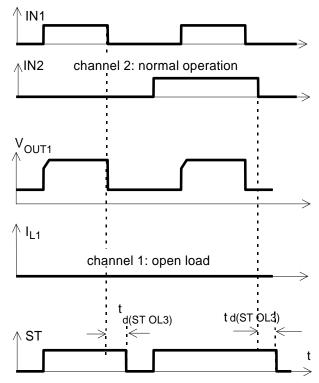


Figure 5a: Open load: detection in OFF-state, turn on/off to open load



 $t_{\text{d(ST,OL3)}}\ \text{depends}$ on external circuitry because of high impedance

*) $I_{L} = 30 \, \mu A \, typ$

Figure 6a: Undervoltage:

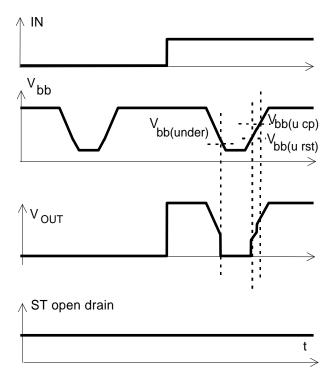
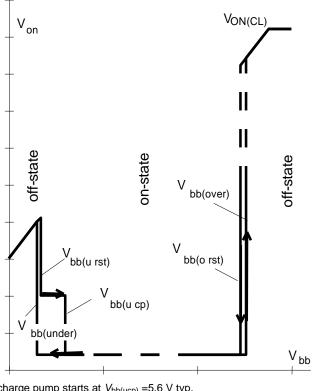


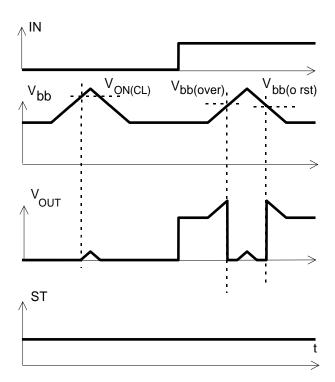


Figure 6b: Undervoltage restart of charge pump



charge pump starts at $V_{bb(ucp)}$ =5.6 V typ.

Figure 7a: Overvoltage:



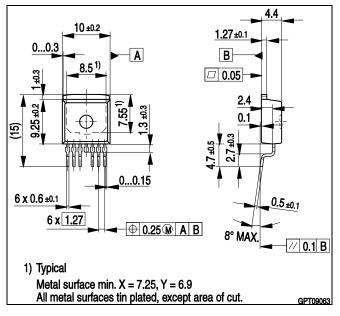


Package and Ordering Code

All dimensions in mm

 PG-TO263-7-2
 Ordering code

 BTS612N1 E3128A
 SP001104824



Published by Infineon Technologies AG, D-81726 München © Infineon Technologies AG 2013 All Rights Reserved.

Attention please!

The information herein is given to describe certain components and shall not be considered as a guarantee of characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Infineon Technologies is an approved CECC manufacturer.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives worldwide (see address list).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in lifesupport devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.